r r С 0 |r | E 0 m Dr m el r Search Text DBs Time Stamp L # Hits Type f 0 i r t n s i t i 0 n USPAT; wafer adj etch\$3 adj 2000/01/12 0 BRS L119 EPO; 09:29 bath JPO USPAT; 2000/01/12 wafer adj etch\$3 adj EPO; 0 23 L22 BRS bath 09:44 JPO USPAT; 2000/01/12 0 EPO; 0 etach\$3 adj fluid 3 BRS L3 09:45 JPO USPAT; 2000/01/12 EPO; 0 420 etch\$3 adj fluid 4 BRS L409:46 JPO USPAT; 2000/01/12 0 etch\$3 adj bath EPO; 5 BRS L51628 09:47 JPO USPAT; 2000/01/12 0 EPO; L6 160 5 and drain\$3 6 BRS 09:47 JPO USPAT; 2000/01/12 0 EPO; L7 58 6 and wafer BRS 09:47 JPO USPAT; 2000/01/12 EPO; 0 6 and bath 8 BRS L8 160 09:48 JPO USPAT; 2000/01/12 0 6 and valve EPO; 9 BRS L10 30 09:48 JPO

Ε r r С 0 0 r E m D r m er DBs Time Stamp L # Hits Search Text Type е f 0 n i | r t n i t i 0 n USPAT; 2000/01/12 EPO; 0 95 6 and drain\$3 and top 10 BRS L11 09:50 JPO USPAT; 2000/01/12 0 EPO; 11 BRS L12 24 11 and 10 09:50 JPO USPAT; 2000/01/12 0 EPO; 13 and hf 12 BRS L15 3 09:50 JPO USPAT; 2000/01/12 0 EPO; 13 10 12 and 7 BRS L16 09:57 JPO USPAT; 2000/01/12 0 EPO; 7 8 and 9 14 BRS L17 10:03 JPO USPAT; 2000/01/12 0 EPO; L19 24 10 and 11 15 BRS 10:04 JPO USPAT; 2000/01/12 EPO; 0 9 and 8 and 24 16 BRS L20 10:35 JPO USPAT; 2000/01/12 0 EPO; 17 BRS L21 158 4 and clean\$3 10:36 JPO USPAT; 2000/01/12 0 EPO; BRS 52 21 and bath 18 L22 10:36 JPO

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r r C o 0 m Dr m e r Time Stamp Туре L # Hits Search Text DBs f 0 i r n t n s s i t i 0 n USPAT; 22 and (hingley adj\$10 rleas\$3 adj\$10 door) 2000/01/12 EPO; 0 19 BRS L23 29 10:38 JPO USPAT; 2000/01/12 EPO; 0 6 and door 20 BRS L24 10:45 JPO